

FORM PTO-1595  
(Rev. 6-93)

05-03-2002

4/25/02  
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04/25/02

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):  
Satya Prakash Arya and Tzong-Shii Pan  
  
Additional name(s) of conveying party(ies) attached?  
 Yes  No

2. Name and address of receiving party(ies):  
  
Name: International Business Machines Corp.  
  
Internal Address: \_\_\_\_\_  
  
Street Address: New Orchard Road  
  
City: Armonk State: NY Zip: 10504  
  
Country: USA  
  
Additional name(s) & address(es) attached? Yes  No

3. Nature of conveyance:  
  
 Assignment  Merger  
  
 Security Agreement  Change of Name  
  
 Other - \_\_\_\_\_

Execution Date: April 17, 2002 and April 18, 2002

4. Application number(s) or patent number(s): 10132594

If this document is being filed together with a new application, the execution date of the application is:  
April 17, 2002 and April 18, 2002

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Walter W. Duft

Internal Address: Same as below

Street Address: 10255 Main Street, Suite 10

City: Clarence State: New York Zip: 14031

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R. 3.41).....\$ 40.00

Enclosed  
 Authorized to be charged to deposit account

8. Deposit account number:

09-0466

(Attached duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Walter W. Duft  
Name of Person Signing

[Signature]  
Signature

April 25, 2002  
Date

Total number of pages including cover sheet, attachments, and document: 2

Mail documents to be recorded with required cover sheet information to:  
COMMISSIONER OF PATENTS AND TRADEMARKS, BOX ASSIGNMENTS WASHINGTON, D.C. 20231  
PATENT

REEL: 012845 FRAME: 0284

Whereas, we

INVENTOR  
AND CITY

Satya Prakash Arya  
County of Santa Clara  
Tzong-Shii Pan  
County of Santa Clara

of San Jose,  
and State of California,  
of San Jose,  
and State of California

have invented certain improvements in

LAMINATED SUSPENSION DESIGN WITH DUAL PRIMARY METAL LAYERS SANDWICHING INTERMEDIATE SECONDARY LAYER

DATES THAT INVENTORS SIGNED THE APPLICATION and executed, respectively, a United States patent application therefor on (1) 04/17/, 2002, and (2) April 18, 2002,

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and sealed

CITY	(1) at <u>San Jose</u>	<u>Satya P Arya</u>	SIGNATURE INVENTOR
DATE	on <u>04/17/</u> , 2002,		
CITY	(2) at <u>San Jose</u>	<u>Tzong-Shii Pan</u>	SIGNATURE INVENTOR
DATE	on <u>4/18</u> , 2002,		